



Click here for the 3D model.

| Dimensions | |
|------------|--|
| Chip Size | 0805 |
| L | 2.03mm +/-0.38mm (0.08 in +/-0.015 in) |
| W | 1.27mm +/-0.38mm (0.05 in +/-0.015 in) |
| Т | 1.4mm MAX (0.055 in MAX) |
| В | 0.51mm +/-0.25mm (0.02 in +/-0.01 in) |

| General Information | | | |
|-------------------------|-----------------|--|--|
| Series | GR900 SMD Space | | |
| Style | SMD Chip | | |
| RoHS | Yes | | |
| Termination | Tin | | |
| Failure Rate | N/A | | |
| Testing and Reliability | GR900 CSAM A | | |
| AEC-Q200 | No | | |
| Shelf Life | 78 Weeks | | |
| MSL | 1 | | |

| Specifications | | | |
|-------------------------|------------|--|--|
| Capacitance | 1500 pF | | |
| Capacitance Tolerance | 5% | | |
| Voltage DC | 100 VDC | | |
| Temperature Range | -55/+125°C | | |
| Temperature Coefficient | BX | | |

Packaging Specifications

Packaging

Bulk, Bag

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